



# 74ALVCH162244

## LOW VOLTAGE CMOS 16-BIT BUS BUFFER (3-STATE) WITH 3.6V TOLERANT INPUTS AND OUTPUTS

- 3.6V TOLERANT INPUTS AND OUTPUTS
- HIGH SPEED :
  - $t_{PD} = 4.2 \text{ ns (MAX.)}$  at  $V_{CC} = 3.0 \text{ to } 3.6\text{V}$
  - $t_{PD} = 4.9 \text{ ns (MAX.)}$  at  $V_{CC} = 2.3 \text{ to } 2.7\text{V}$
  - $t_{PD} = 6.1\text{ns (MAX.)}$  at  $V_{CC} = 1.65 \text{ V}$
- POWER DOWN PROTECTION ON INPUTS AND OUTPUTS
- SYMMETRICAL OUTPUT IMPEDANCE:
  - $|I_{OH}| = I_{OL} = 12\text{mA (MIN)}$  at  $V_{CC} = 3.0\text{V}$
  - $|I_{OH}| = I_{OL} = 6\text{mA (MIN)}$  at  $V_{CC} = 2.3\text{V}$
  - $|I_{OH}| = I_{OL} = 2\text{mA (MIN)}$  at  $V_{CC} = 1.65\text{V}$
- 26Ω SERIE RESISTORS IN OUTPUTS
- OPERATING VOLTAGE RANGE:
  - $V_{CC(OPR)} = 1.65\text{V to } 3.6\text{V}$
- BUS HOLD PROVIDED ON DATA INPUTS
- PIN AND FUNCTION COMPATIBLE WITH 74 SERIES 162244
- LATCH-UP PERFORMANCE EXCEEDS 300mA (JESD 17)
- ESD PERFORMANCE:
  - HBM > 2000V (MIL STD 883 method 3015);
  - MM > 200V

### DESCRIPTION

The 74ALVCH162244 is a low voltage CMOS 16 BIT BUS BUFFER (NON INVERTED) fabricated with sub-micron silicon gate and five-layer metal wiring C<sup>2</sup>MOS technology. It is ideal for low power and very high speed 1.65 to 3.6V applications; it can be interfaced to 3.6V signal environment for both inputs and outputs.

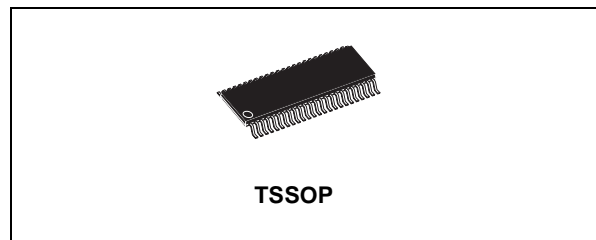
Any  $\overline{nG}$  output control governs four BUS BUFFERS. Output Enable input ( $\overline{nG}$ ) tied together gives full 16-bit operation.

When  $\overline{nG}$  is LOW, the outputs are enabled. When  $\overline{nG}$  is HIGH, the output are in high impedance state.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level. This device is designed to be used with 3 state memory address drivers, etc.

The device circuits is including 26Ω series resistance in the outputs. These resistors permit to reduce line noise in high speed applications.

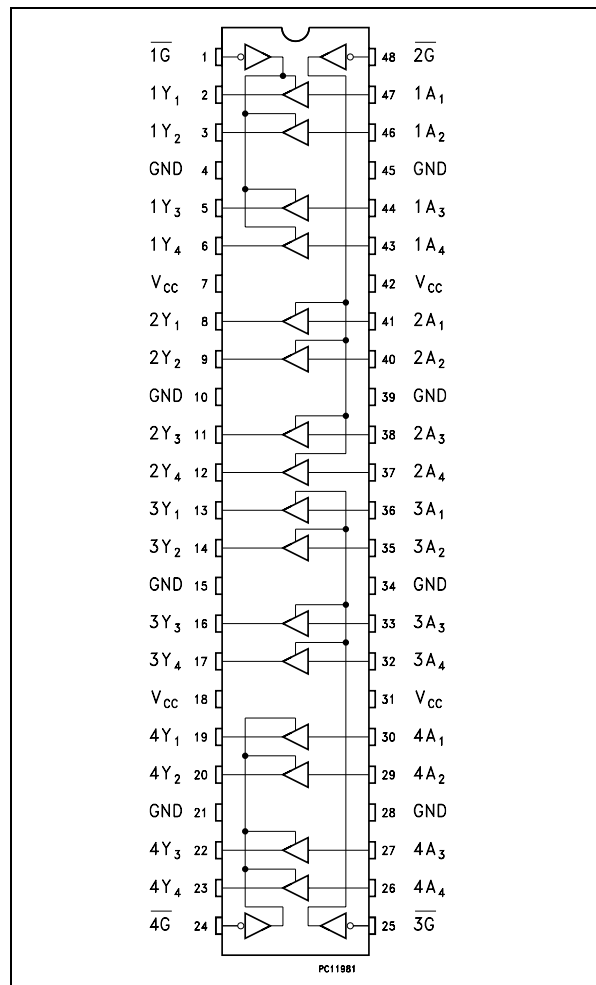
All inputs and outputs are equipped with protection circuits against static discharge gghem 2KV ESD immunity and transient excess voltage.



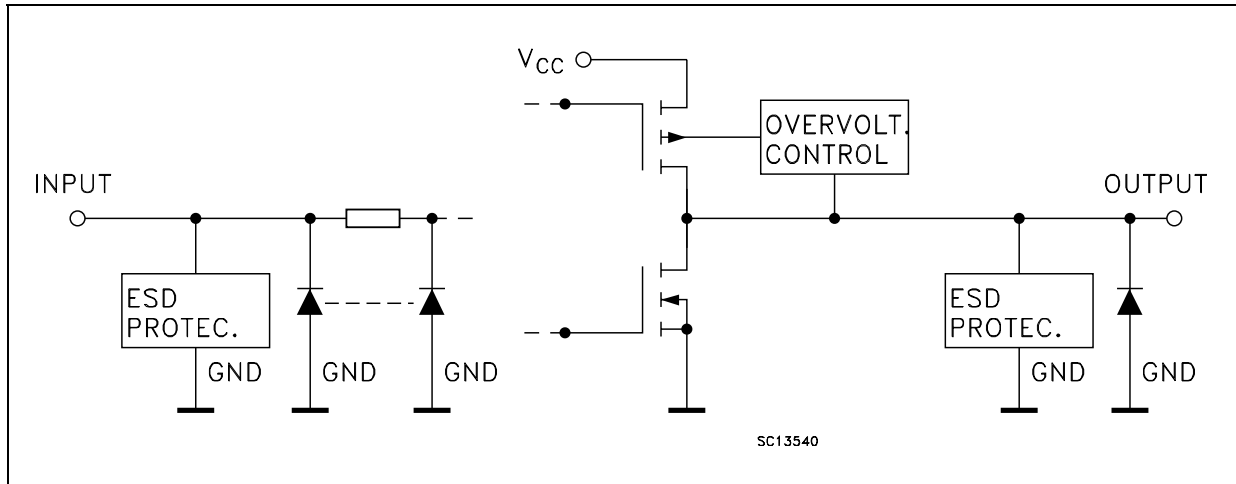
### ORDER CODES

PACKAGE	TUBE	T & R
TSSOP		74ALVCH162244TTR

### PIN CONNECTION



INPUT AND OUTPUT EQUIVALENT CIRCUIT



PIN DESCRIPTION

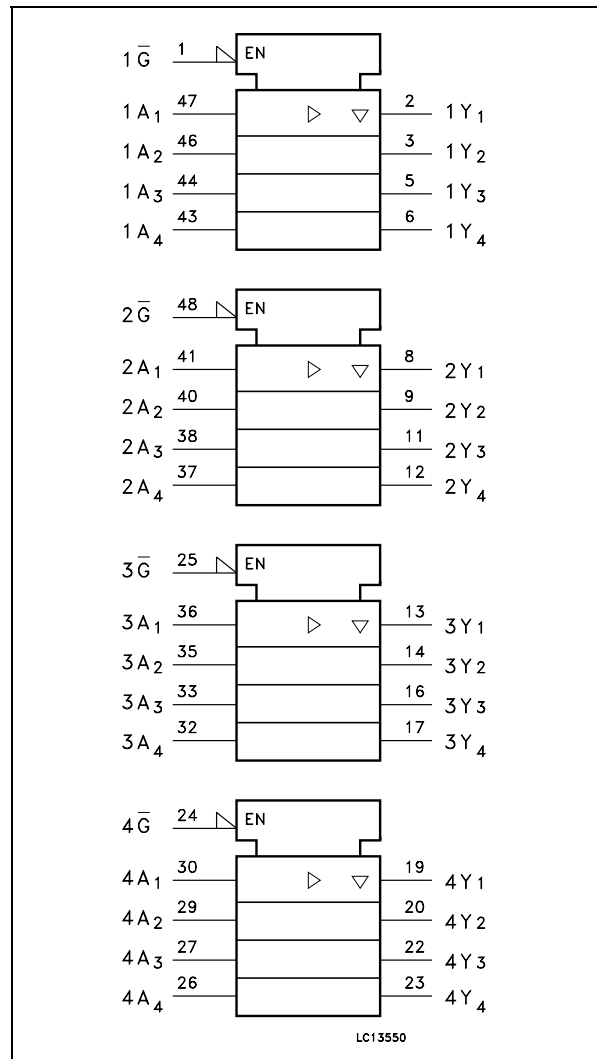
PIN No	SYMBOL	NAME AND FUNCTION
1	1G	Output Enable Input
2, 3, 5, 6	1Y1 to 1Y4	Data Outputs
8, 9, 11, 12	2Y1 to 2Y4	Data Outputs
13, 14, 16, 17	3Y1 to 3Y4	Data Outputs
19, 20, 22, 23	4Y1 to 4Y4	Data Outputs
24	4G	Output Enable Input
25	3G	Output Enable Input
30, 29, 27, 26	4A1 to 4A4	Data Outputs
36, 35, 33, 32	3A1 to 3A4	Data Outputs
41, 40, 38, 37	2A1 to 2A4	Data Outputs
47, 46, 44, 43	1A1 to 1A4	Data Outputs
48	2G	Output Enable Input
4, 10, 15, 21, 28, 34, 39, 45	GND	Ground (0V)
7, 18, 31, 42	V <sub>CC</sub>	Positive Supply Voltage

TRUTH TABLE

INPUTS		OUTPUT
$\bar{G}$	A <sub>n</sub>	Y <sub>n</sub>
L	L	L
L	H	H
H	X	Z

X : Don't Care  
Z : High Impedance

IEC LOGIC SYMBOLS



**ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply Voltage	-0.5 to +4.6	V
$V_I$	DC Input Voltage	-0.5 to +4.6	V
$V_O$	DC Output Voltage (OFF State)	-0.5 to +4.6	V
$V_O$	DC Output Voltage (High or Low State) (note 1)	-0.5 to $V_{CC} + 0.5$	V
$I_{IK}$	DC Input Diode Current	- 50	mA
$I_{OK}$	DC Output Diode Current (note 2)	- 50	mA
$I_O$	DC Output Current	$\pm 50$	mA
$I_{CC}$ or $I_{GND}$	DC $V_{CC}$ or Ground Current per Supply Pin	$\pm 100$	mA
$P_D$	Power Dissipation	400	mW
$T_{stg}$	Storage Temperature	-65 to +150	°C
$T_L$	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied

1)  $I_O$  absolute maximum rating must be observed

2)  $V_O < GND$ ,  $V_O > V_{CC}$

**RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply Voltage	1.65 to 3.6	V
$V_I$	Input Voltage	-0.3 to 3.6	V
$V_O$	Output Voltage (OFF State)	0 to 3.6	V
$V_O$	Output Voltage (High or Low State)	0 to $V_{CC}$	V
$I_{OH}$ , $I_{OL}$	High or Low Level Output Current ( $V_{CC} = 3.0$ to $3.6V$ )	$\pm 12$	mA
$I_{OH}$ , $I_{OL}$	High or Low Level Output Current ( $V_{CC} = 2.3$ to $2.7V$ )	$\pm 6$	mA
$I_{OH}$ , $I_{OL}$	High or Low Level Output Current ( $V_{CC} = 1.65V$ )	$\pm 2$	mA
$T_{op}$	Operating Temperature	-55 to 125	°C
dt/dv	Input Rise and Fall Time (note 1)	0 to 10	ns/V

1)  $V_{IN}$  from 0.8V to 2V at  $V_{CC} = 3.0V$

## DC SPECIFICATIONS

Symbol	Parameter	Test Condition		Value				Unit
		V <sub>CC</sub> (V)		-40 to 85 °C		-55 to 125 °C		
				Min.	Max.	Min.	Max.	
V <sub>IH</sub>	High Level Input Voltage	1.65 to 1.95		0.65 V <sub>CC</sub>		0.65 V <sub>CC</sub>		V
		2.3 to 2.7		1.7		1.7		
		2.7 to 3.6		2.0		2.0		
V <sub>IL</sub>	Low Level Input Voltage	1.65 to 1.95			0.35 V <sub>CC</sub>		0.35 V <sub>CC</sub>	V
		2.3 to 2.7			0.7		0.7	
		2.7 to 3.6			0.8		0.8	
V <sub>OH</sub>	High Level Output Voltage	1.65 to 3.6	I <sub>O</sub> =-100 μA	V <sub>CC</sub> -0.2		V <sub>CC</sub> -0.2		V
		1.65	I <sub>O</sub> =-2 mA	1.2		1.2		
		2.3	I <sub>O</sub> =-4 mA	1.9		1.9		
		2.3	I <sub>O</sub> =-6 mA	1.7		1.7		
		2.7	I <sub>O</sub> =-8 mA	2.0		2.0		
		3.0	I <sub>O</sub> =-6 mA	2.4		2.4		
		3.0	I <sub>O</sub> =-12 mA	2.0		2.0		
V <sub>OL</sub>	Low Level Output Voltage	1.65 to 3.6	I <sub>O</sub> =100 μA		0.2		0.2	V
		1.65	I <sub>O</sub> =2 mA		0.45		0.45	
		2.3	I <sub>O</sub> =4 mA		0.4		0.4	
		2.3	I <sub>O</sub> =6 mA		0.55		0.7	
		2.7	I <sub>O</sub> =8 mA		0.6		0.4	
		3.0	I <sub>O</sub> =12 mA		0.8		0.55	
I <sub>I</sub>	Input Leakage Current	3.6	V <sub>I</sub> = 0 or 3.6V		± 5		± 5	μA
I <sub>IHOLD</sub>	Bus Hold Input Leakage Current	1.65	V <sub>I</sub> =0.58 V	+ 25		+ 25		μA
		1.65	V <sub>I</sub> =1.07 V	- 25		- 25		
		2.3	V <sub>I</sub> =0.7 V	+ 45		+ 45		
		2.3	V <sub>I</sub> =1.7 V	- 45		- 45		
		3.0	V <sub>I</sub> =0.8 V	+ 75		+ 75		
		3.0	V <sub>I</sub> =2 V	- 75		- 75		
		3.6	V <sub>I</sub> = 0 to 3.6 V		± 500		± 500	
I <sub>off</sub>	Power Off Leakage Current	0	V <sub>I</sub> or V <sub>O</sub> = 3.6V		10		20	μA
I <sub>OZ</sub>	High Impedance Output Leakage Current	3.6	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>O</sub> = 0 to V <sub>CC</sub>		± 5		± 10	μA
I <sub>CC</sub>	Quiescent Supply Current	3.6	V <sub>I</sub> = V <sub>CC</sub> or GND I <sub>O</sub> = 0		20		40	μA
ΔI <sub>CC</sub>	I <sub>CC</sub> incr. per Input	3.0 to 3.6	V <sub>IH</sub> = V <sub>CC</sub> - 0.6V		500		750	μA

## AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Condition				Value				Unit
		V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	R <sub>L</sub> (Ω)	t <sub>s</sub> = t <sub>r</sub> (ns)	-40 to 85 °C		-55 to 125 °C		
						Min.	Max.	Min.	Max.	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time	1.65 to 1.95	30	1000	2.0	1	6.1	1	6.1	ns
		2.3 to 2.7	30	500	2.0	1	4.9	1	4.9	
		2.7	50	500	2.5	1	4.7	1	4.7	
		3.0 to 3.6	50	500	2.5	1	4.2	1	4.2	
t <sub>PZL</sub> t <sub>PZH</sub>	Output Enable Time	1.65 to 1.95	30	1000	2.0	1	8		8	
		2.3 to 2.7	30	500	2.0	1	6.8	1	6.8	
		2.7	50	500	2.5	1	6.7	1	6.7	
		3.0 to 3.6	50	500	2.5	1	5.6	1	5.6	
t <sub>PLZ</sub> t <sub>PHZ</sub>	Output Disable Time	1.65 to 1.95	30	1000	2.0	1	7.5	1	7.5	
		2.3 to 2.7	30	500	2.0	1	6.3	1	6.3	
		2.7	50	500	2.5	1	5.7	1	5.7	
		3.0 to 3.6	50	500	2.5	1	5.5	1	5.5	

1) Skew is defined as the absolute value of the difference between the actual propagation delay for any two outputs of the same device switching in the same direction, either HIGH or LOW ( $t_{OSLH} = |t_{PLHm} - t_{PLHn}|$ ;  $t_{OSHL} = |t_{PHLm} - t_{PHLn}|$ )

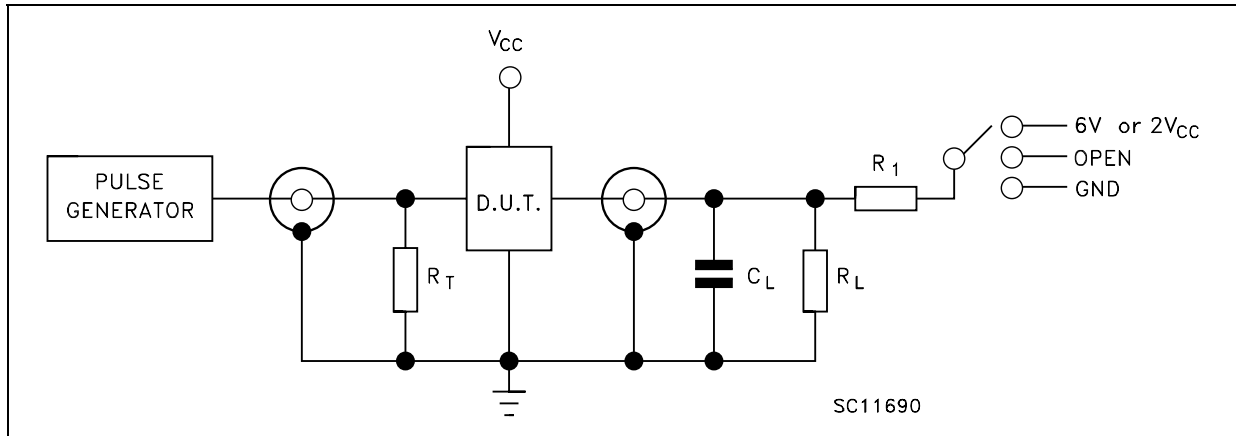
2) Parameter guaranteed by design

## CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Test Condition		Value			Unit
		V <sub>CC</sub> (V)		T <sub>A</sub> = 25 °C			
				Min.	Typ.	Max.	
C <sub>IN</sub>	Input Capacitance Control Inputs	3.3	V <sub>IN</sub> = V <sub>CC</sub> or GND		3		pF
C <sub>IN</sub>	Input Capacitance Data Inputs	3.3	V <sub>IN</sub> = V <sub>CC</sub> or GND		6		pF
C <sub>OUT</sub>	Output Capacitance	3.3	V <sub>IN</sub> = 0 to V <sub>CC</sub>		7		pF
C <sub>PD</sub>	Power Dissipation Capacitance Output enabled (note 1)	3.3	f <sub>IN</sub> = 10MHz C <sub>L</sub> = 50pF V <sub>IN</sub> = 0 or V <sub>CC</sub>		19		pF
		2.5			16		
C <sub>PD</sub>	Power Dissipation Capacitance Output disabled (note 1)	3.3			5		
		2.5			4		

1) C<sub>PD</sub> is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operating current can be obtained by the following equation.  $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/16$  (per circuit)

TEST CIRCUIT

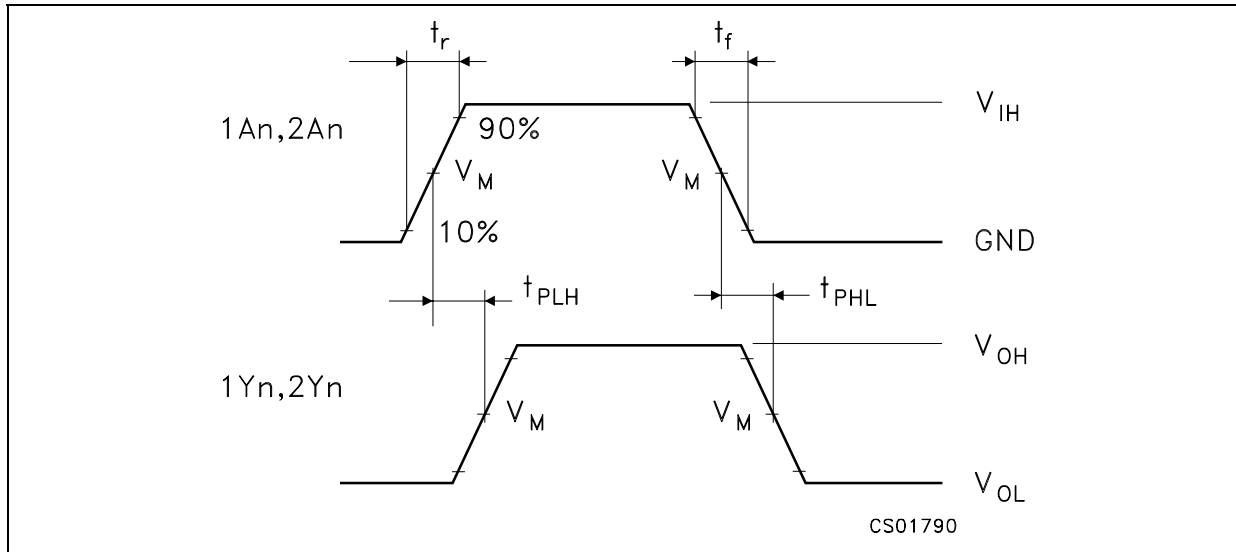
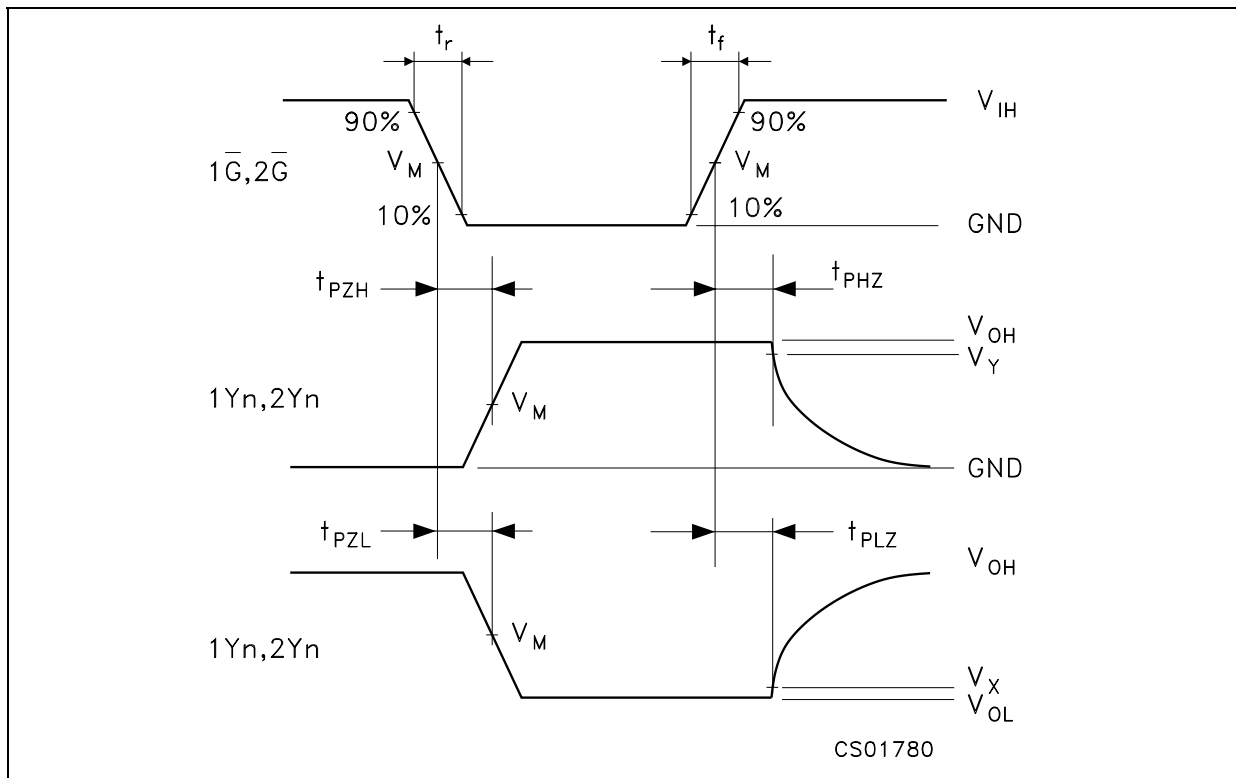


TEST	SWITCH
$t_{PLH}$ , $t_{PHL}$	Open
$t_{PZL}$ , $t_{PLZ}$ ( $V_{CC} = 3.0$ to $3.6V$ )	6V
$t_{PZL}$ , $t_{PLZ}$ ( $V_{CC} = 2.3$ to $2.7V$ )	$2V_{CC}$
$t_{PZH}$ , $t_{PHZ}$	GND

$R_T = Z_{OUT}$  of pulse generator (typically  $50\Omega$ )

TEST CIRCUIT AND WAVEFORM SYMBOL VALUE

Symbol	$V_{CC}$			
	3.0 to 3.6V	2.7V	2.3 to 2.7V	1.65 to 1.95V
$V_{IH}$	2.7V	2.7V	$V_{CC}$	$V_{CC}$
$V_M$	1.5V	1.5V	$V_{CC}/2$	$V_{CC}/2$
$V_X$	$V_{OL} + 0.3V$	$V_{OL} + 0.3V$	$V_{OL} + 0.15V$	$V_{OL} + 0.15V$
$V_Y$	$V_{OH} - 0.3V$	$V_{OH} - 0.3V$	$V_{OH} - 0.15V$	$V_{OH} - 0.15V$
$C_L$	50pF	50pF	30pF	30pF
$R_L = R_1$	500 $\Omega$	500 $\Omega$	500 $\Omega$	1000 $\Omega$
$t_r = t_f$	<2.5ns	<2.5ns	<2.0ns	<2.0ns

**WAVEFORM 1 : PROPAGATION DELAYS** (f=1MHz; 50% duty cycle)**WAVEFORM 2 : OUTPUT ENABLE AND DISABLE TIME** (f=1MHz; 50% duty cycle)

## TSSOP48 MECHANICAL DATA

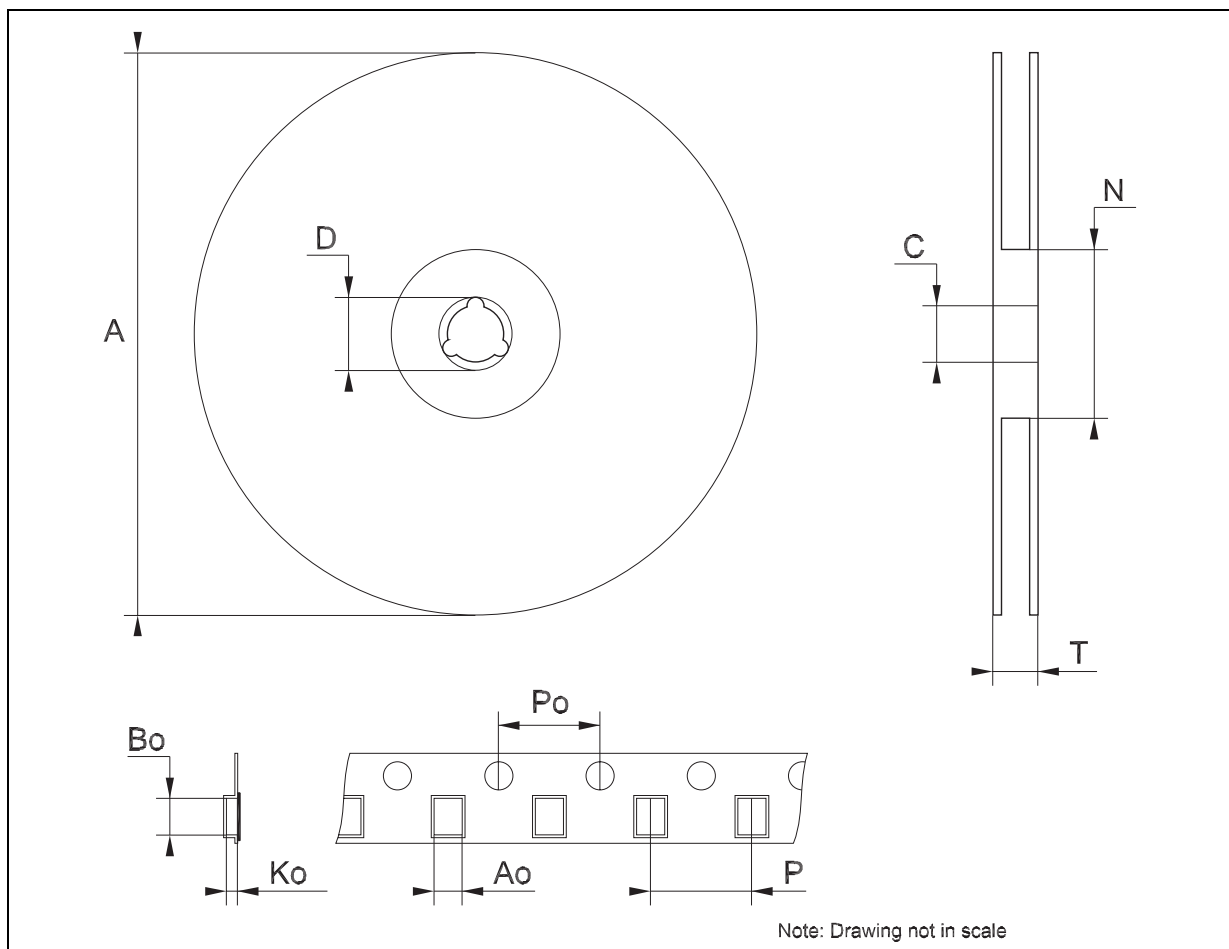
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002		0.006
A2		0.9			0.035	
b	0.17		0.27	0.0067		0.011
c	0.09		0.20	0.0035		0.0079
D	12.4		12.6	0.488		0.496
E		8.1 BSC			0.318 BSC	
E1	6.0		6.2	0.236		0.244
e		0.5 BSC			0.0197 BSC	
K	0°		8°	0°		8°
L	0.50		0.75	0.020		0.030





### Tape & Reel TSSOP48 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			30.4			1.197
Ao	8.7		8.9	0.343		0.350
Bo	13.1		13.3	0.516		0.524
Ko	1.5		1.7	0.059		0.067
Po	3.9		4.1	0.153		0.161
P	11.9		12.1	0.468		0.476



Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

© The ST logo is a registered trademark of STMicroelectronics

© 2002 STMicroelectronics - Printed in Italy - All Rights Reserved  
STMicroelectronics GROUP OF COMPANIES

Australia - Brazil - Canada - China - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco  
Singapore - Spain - Sweden - Switzerland - United Kingdom - United States.

© <http://www.st.com>